N-Channel Depletion-Mode Vertical DMOS FETs

Ordering Information

BV_{DSX} / BV_{DGX}	$R_{DS(ON)}$ (max)	I_{DSS} (min)	Order Number / Package	
			TO-243AA*	Die**
350V	10Ω	200mA	DN3535N8	DN3535NW

* Same as SOT-89. Products shipped on 2000 piece carrier tape reels.
** Die in wafer form.

Product marking for TO-243AA:

DN5S*

Where *= 2-week alpha date code

Features

- ❑ High input impedance
- ❑ Low input capacitance
- ❑ Fast switching speeds
- ❑ Low on resistance
- ❑ Free from secondary breakdown
- ❑ Low input and output leakage

Applications

- ❑ Normally-on switches
- ❑ Solid state relays
- ❑ Converters
- ❑ Linear amplifiers
- ❑ Constant current sources
- ❑ Power supply circuits
- ❑ Telecom

Absolute Maximum Ratings

Drain-to-Source Voltage	BV_{DSX}
Drain-to-Gate Voltage	BV_{DGX}
Gate-to-Source Voltage	± 20V
Operating and Storage Temperature	55°C to +150°C
Soldering Temperature*	300°C

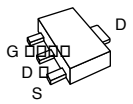
* Distance of 1.6 mm from case for 10 seconds.

Advanced DMOS Technology

These low threshold depletion-mode (normally-on) transistors utilize an advanced vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces devices with the power handling capabilities of bipolar transistors and with the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, these devices are free from thermal runaway and thermally-induced secondary breakdown.

Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

Package Option



TO-243AA
(SOT-89)

12/13/01

Supertex Inc. does not recommend the use of its products in life support applications and will not knowingly sell its products for use in such applications unless it receives an adequate "products liability indemnification insurance agreement." Supertex does not assume responsibility for use of devices described and limits its liability to the replacement of devices determined to be defective due to workmanship. No responsibility is assumed for possible omissions or inaccuracies. Circuitry and specifications are subject to change without notice. For the latest product specifications, refer to the Supertex website: http://www.supertex.com. For complete liability information on all Supertex products, refer to the most current databook or to the Legal/Disclaimer page on the Supertex website.

Thermal Characteristics

Package	I_D (continuous)*	I_D (pulsed)	Power Dissipation @ T_A = 25°C	θ_{jc} °C/W	θ_{ja} °C/W	I_{DR}*	I_{DRM}
TO-243AA	230mA	500mA	1.6W †	15	78†	230mA	500mA

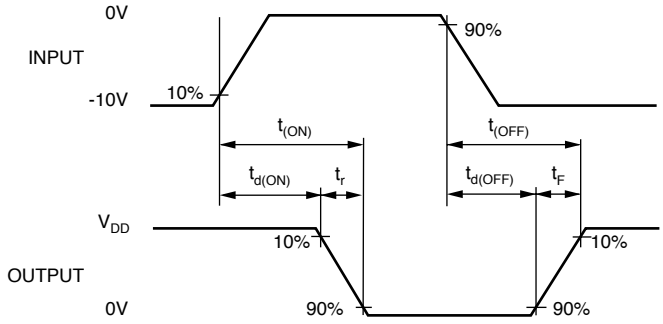
* I_D (continuous) is limited by max rated T_j.
† Mounted on FR4 board, 25mm x 25mm x 1.57mm. Significant P_D increase possible on ceramic substrate.

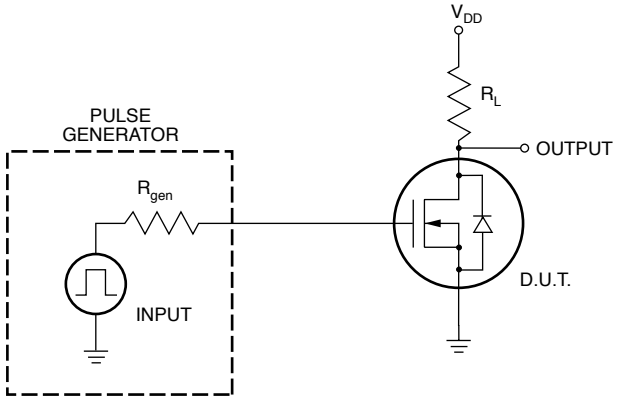
Electrical Characteristics (@ 25°C unless otherwise specified)

Symbol	Parameter	Min	Typ	Max	Unit	Conditions
BV_{DSX}	Drain-to-Souce Breakdown Voltage	350			V	V_{GS} = -5.0V, I_D = 1.0μA
$V_{GS(OFF)}$	Gate-to-Source OFF Voltage	-1.5		-3.5	V	V_{DS} = 15V, I_D = 10μA
$\Delta V_{GS(OFF)}$	Change in $V_{GS(OFF)}$ with Temperature			4.5	mV/°C	V_{DS} = 15V, I_D = 10μA
I_{GSS}	Gate Body Leakage Current			100	nA	V_{GS} = ±20V, V_{DS} = 0V
$I_{D(OFF)}$	Drain-to-Source Leakage Current			1.0	μA	V_{GS} = -5.0V, V_{DS} = Max Rating
				1.0	mA	V_{GS} = -5.0V, V_{DS} = 0.8 Max Rating T_A = 125°C
I_{DSS}	Saturated Drain-to-Source Current	200			mA	V_{GS} = 0V, V_{DS} = 15V
$R_{DS(ON)}$	Static Drain-to-Source ON-State Resistance			10	Ω	V_{GS} = 0V, I_D = 150mA
$\Delta R_{DS(ON)}$	Change in $R_{DS(ON)}$ with Temperature			1.1	%/°C	V_{GS} = 0V, I_D = 150mA
G_{FS}	Forward Transconductance	200			m℧	I_D = 100mA, V_{DS}=10V
C_{ISS}	Input Capacitance			360	pF	V_{GS} = -5.0V, V_{DS} = 25V, f =1.0Mhz
C_{OSS}	Common Source Output Capacitance			40		
C_{RSS}	Reverse Transfer Capacitance			10		
$t_{d(ON)}$	Turn-ON Delay Time			15	ns	V_{DD} = 25V, I_D = 150mA, R_{GEN} = 25Ω, V_{GS} = 0V to -10V
t_r	Rise Time			20		
$t_{d(OFF)}$	Turn-OFF Delay Time			20		
t_f	Fall Time			30		
V_{SD}	Diode Forward Voltage Drop			1.8	V	V_{GS} = -5.0V, I_{SD} = 150mA
t_{rr}	Reverse Recovery Time		800		ns	V_{GS} = -5.0V, I_{SD} = 150mA

Notes:
1. All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300μs pulse, 2% duty cycle.)
2. All A.C. parameters sample tested.

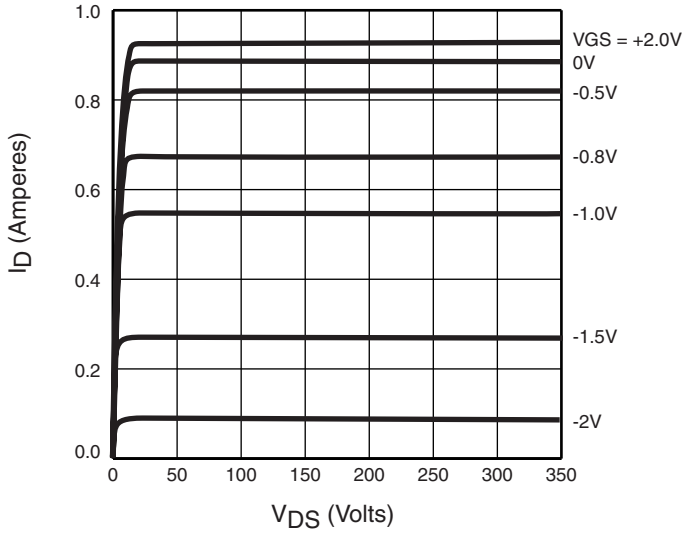
Switching Waveforms and Test Circuit



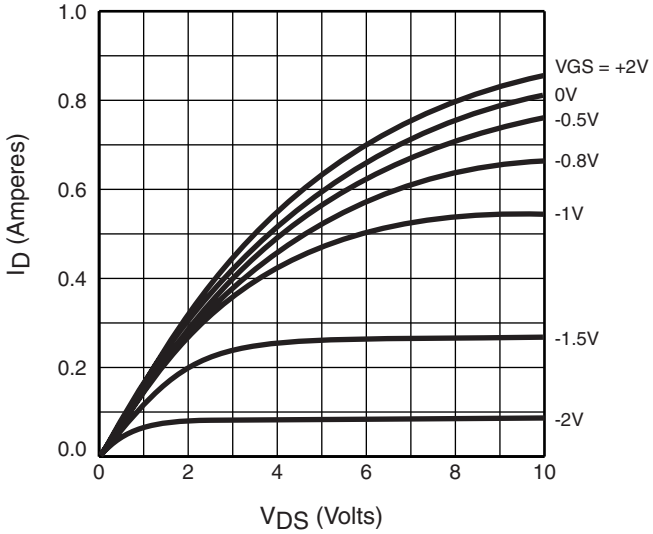


Typical Performance Curves

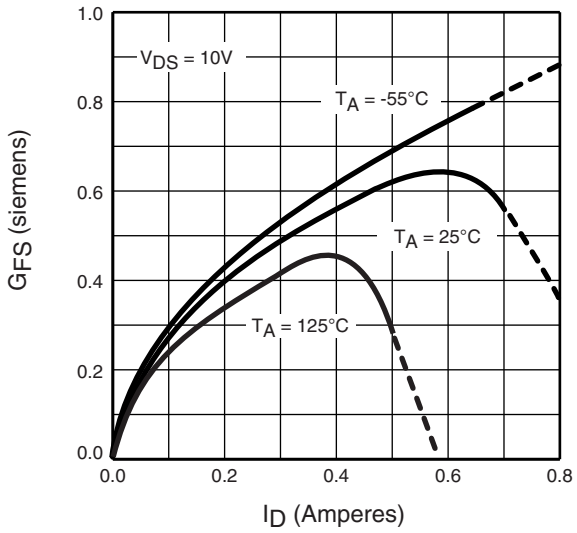
Output Characteristics



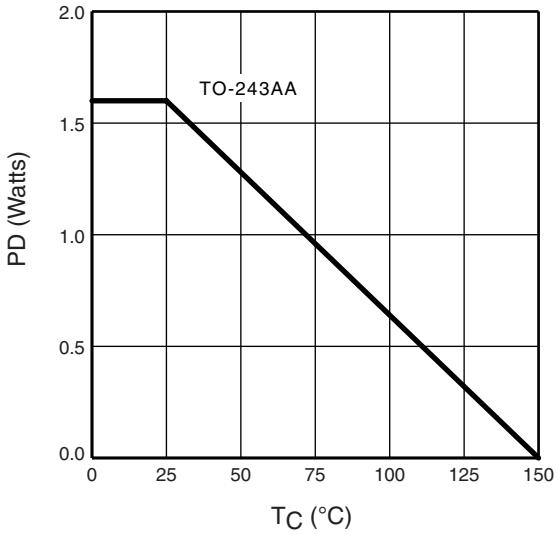
Saturation Characteristics



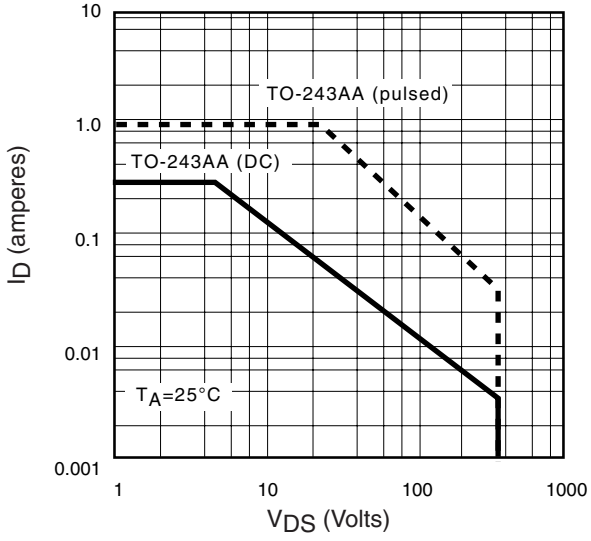
Transconductance vs. Drain Current



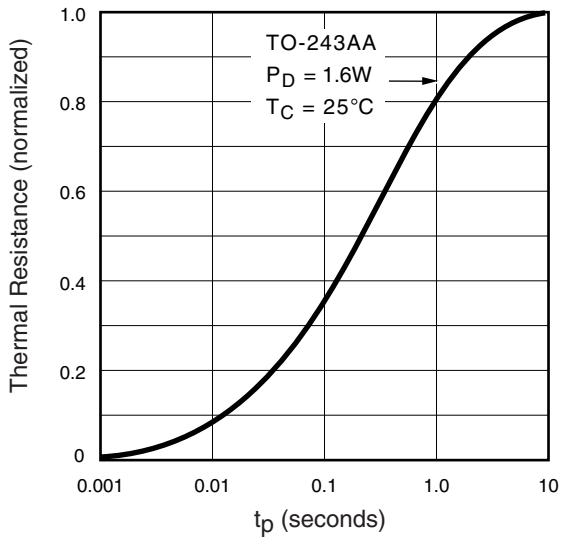
Power Dissipation vs. Case Temperature



Maximum Rated Safe Operating Area

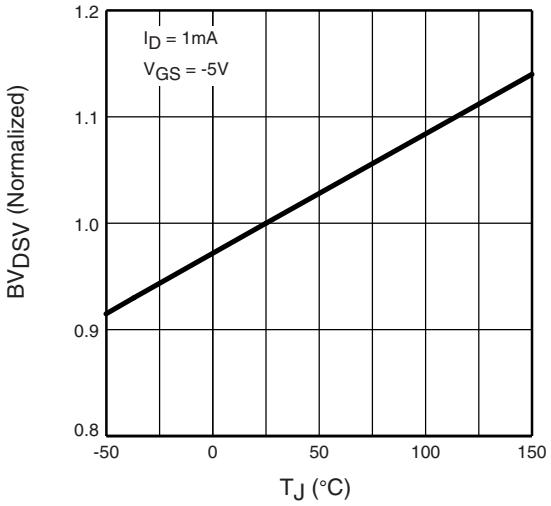


Thermal Response Characteristics

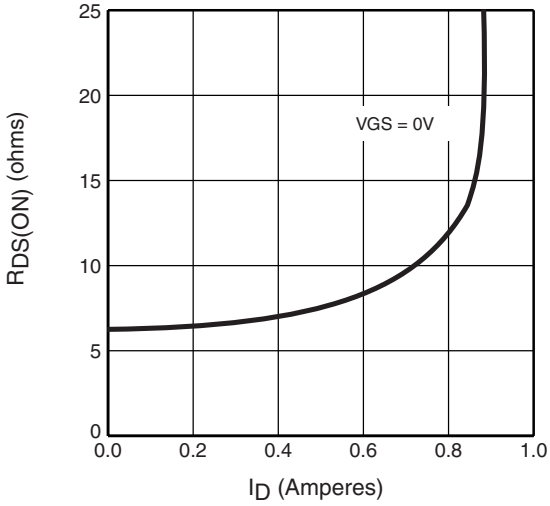


Typical Performance Curves

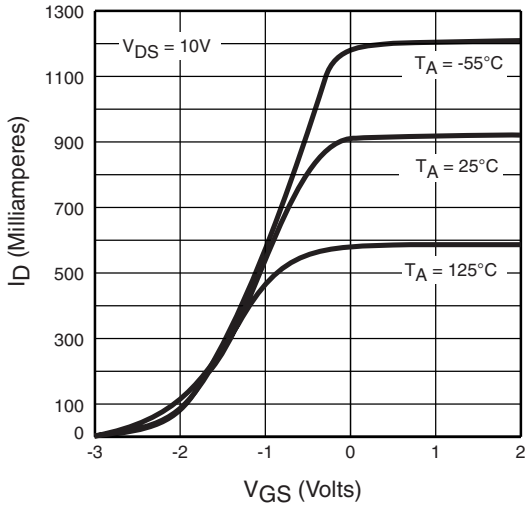
BV_{DSV} Variation with Temperature



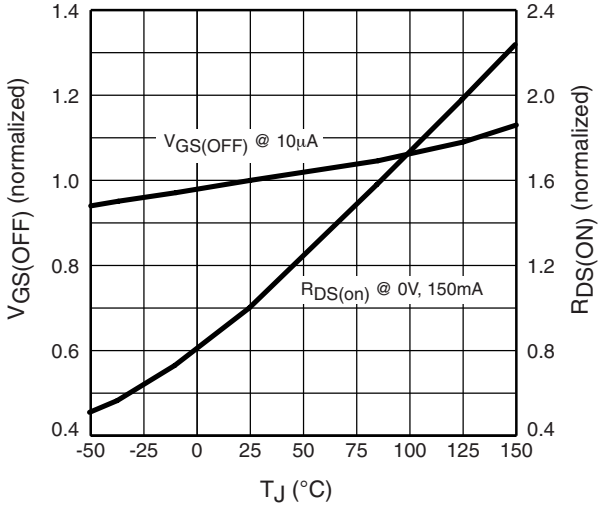
On Resistance vs. Drain Current



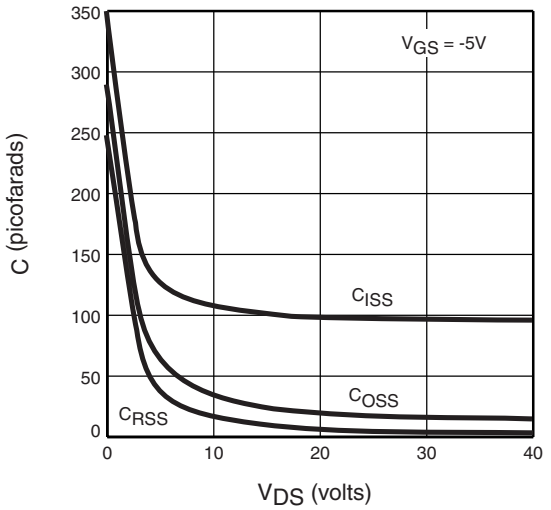
Transfer Characteristics



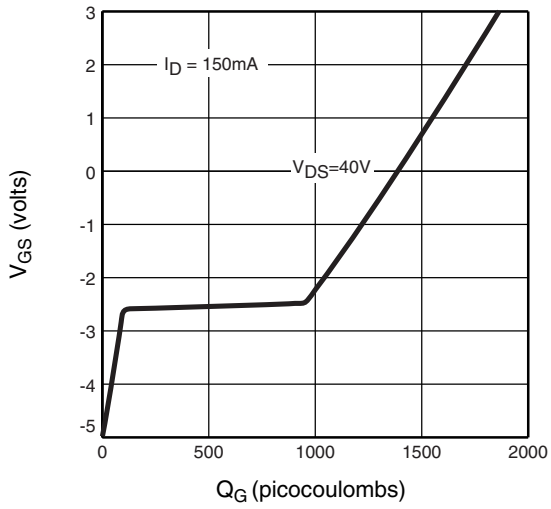
$V_{GS(OFF)}$ and $R_{DS(ON)}$ w/ Temperature



Capacitance vs. Drain Source Voltage



Gate Drive Dynamic Characteristics



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